



LEOPARD IMAGING INC

Rev 1.0

LI-XAVIER-KIT-IMX385CS-X

Data Sheet

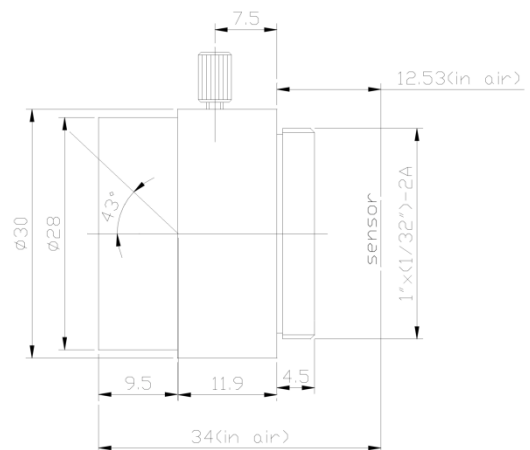
Key Features

- Compatible with Nvidia Jetson AGX Xavier Developer Kit
- MIPI CSI-2 interface
- Support up to two 4-lane cameras or three 2-lane cameras
- Sony Diagonal 8.35mm Type 1/2 CMOS Image Sensor IMX385LQR
- Active pixels: 1937H x 1097V
- Pixel size: 3.75 um x 3.75 um
- Color camera
- Length of the I-PEX cable: 300mm
- Support multiple length cables
- Support IR cut switch
- Support CS lens
- Provide customization services
- Part#:
 - (1 cam) [LI-XAVIER-KIT-IMX385CS](#)
 - (2 cam) [LI-XAVIER-KIT-IMX385CS-D](#)
 - (3 cam) [LI-XAVIER-KIT-IMX385CS-T](#)



Lens Spec

- Model: ES0522F.IR
- Focal length: 5.0 mm
- Aperture, F/#: 2.2
- FOV (D/H/V): 102 °/ 90 °/50 °
- TV Distortion: < -8%
- Mount Type: CS



BOM

Nvidia AGX Xavier Developer Kit not included

#	Items	QTY
1	LI-JTX1-MIPI-ADPT	1
2	LI-IMX385-MIPI-CS	1,2 or 3
3	FAW-1233-03 cable	1,2 or 3



Leopard Imaging Inc.

48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
 Phone: +1-408-263-0988
 Fax: +1-408-217-1960
 Email: sales@leopardimaging.com
 Website: www.leopardimaging.com

LI-XAVIER-KIT-IMX385CS

BOM

#	Items	QTY
1	LI-JTX1-MIPI-ADPT	1
2	LI-IMX385-MIPI-CS	1
3	FAW-1233-03 cable	1



LI-XAVIER-KIT-IMX385CS-D

BOM

#	Items	QTY
1	LI-JTX1-MIPI-ADPT	1
2	LI-IMX385-MIPI-CS	2
3	FAW-1233-03 cable	2



LI-XAVIER-KIT-IMX385CS-T

BOM

#	Items	QTY
1	LI-JTX1-MIPI-ADPT	1
2	LI-IMX385-MIPI-CS	3
3	FAW-1233-03 cable	3

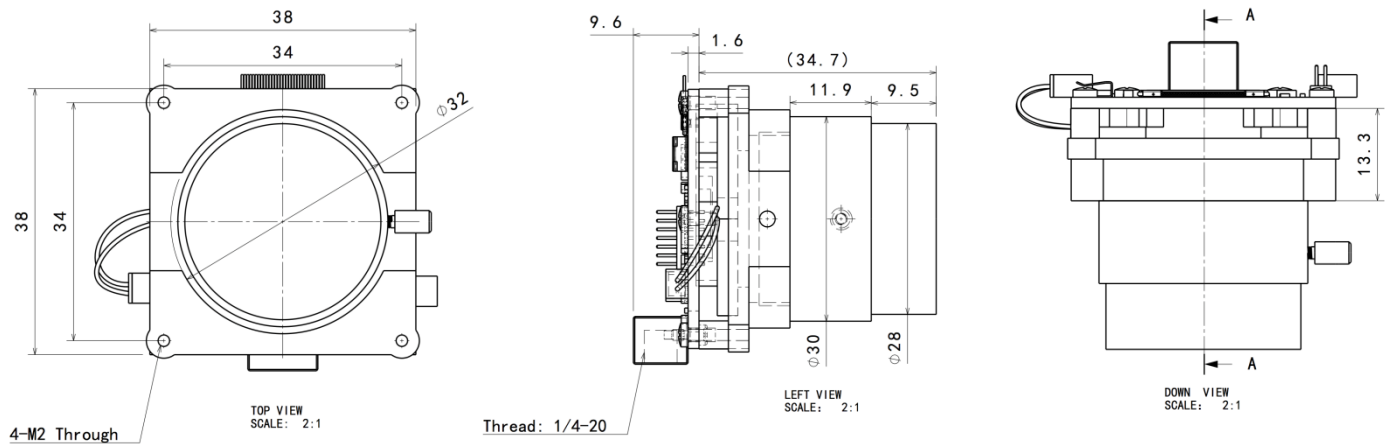


Leopard Imaging Inc.

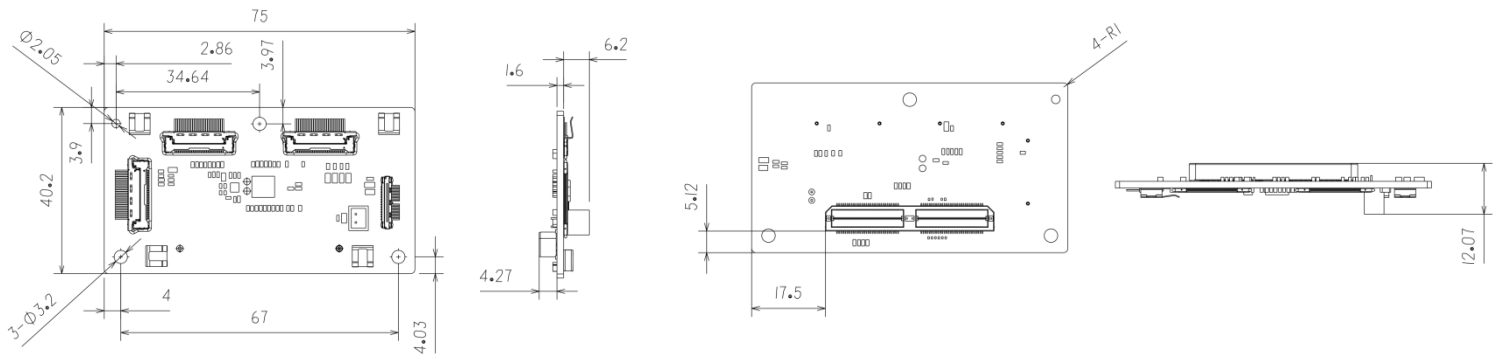
48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
Phone: +1-408-263-0988
Fax: +1-408-217-1960
Email: sales@leopardimaging.com
Website: www.leopardimaging.com

Dimensions

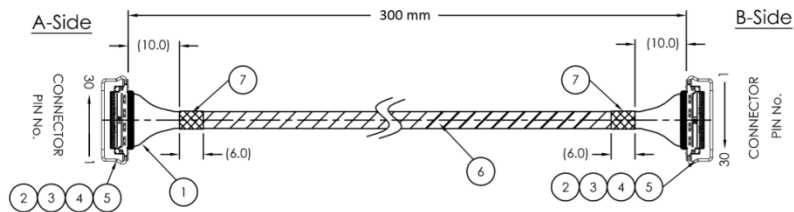
LI-IMX385-MIPI-CS



LI-JTX1-MIPI-ADPT



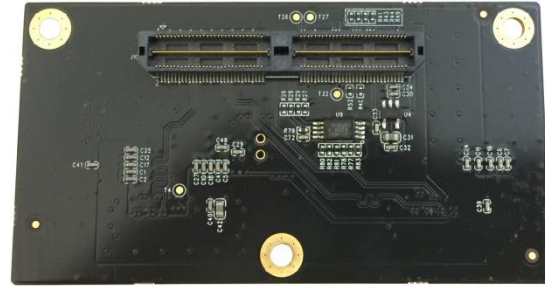
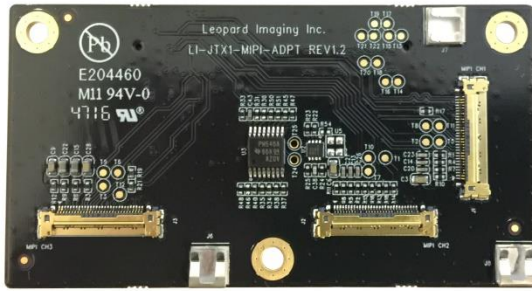
FAW-1233-03



Leopard Imaging Inc.

48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
 Phone: +1-408-263-0988
 Fax: +1-408-217-1960
 Email: sales@leopardimaging.com
 Website: www.leopardimaging.com

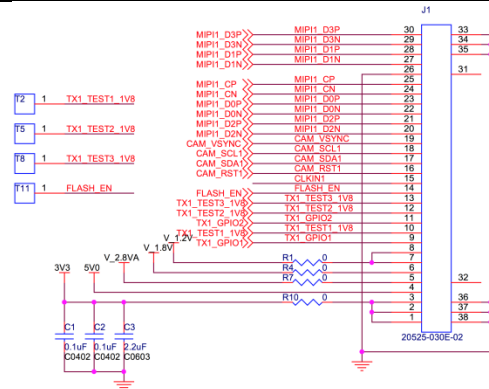
LI-JTX1-MIPI-ADPT



Interfaces

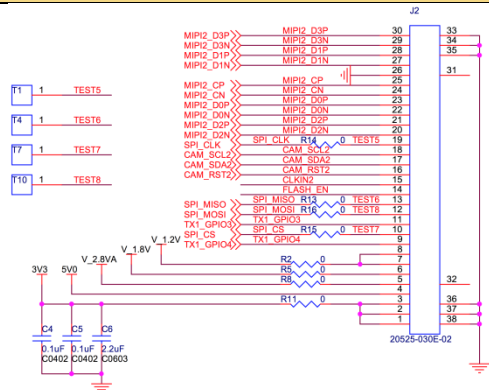
Interface J1

- Part#: 20525-030E-02C
- Number of Positions: 30
- Pitch: 0.4mm
- Mating I-PEX cable: FAW-1233-03 (300mm)



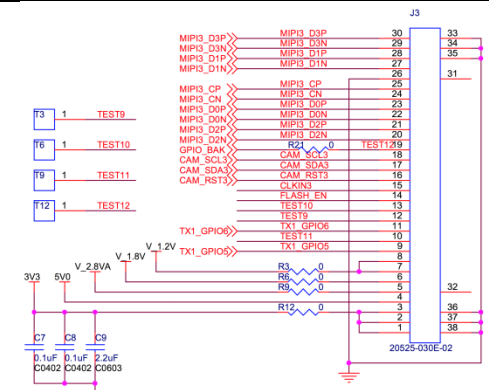
Interface J2

- Part#: 20525-030E-02C
- Number of Positions: 30
- Pitch: 0.4mm
- Mating I-PEX cable: FAW-1233-03 (300mm)



Interface J3

- Part#: 20525-030E-02C
- Number of Positions: 30
- Pitch: 0.4mm
- Mating I-PEX cable: FAW-1233-03 (300mm)



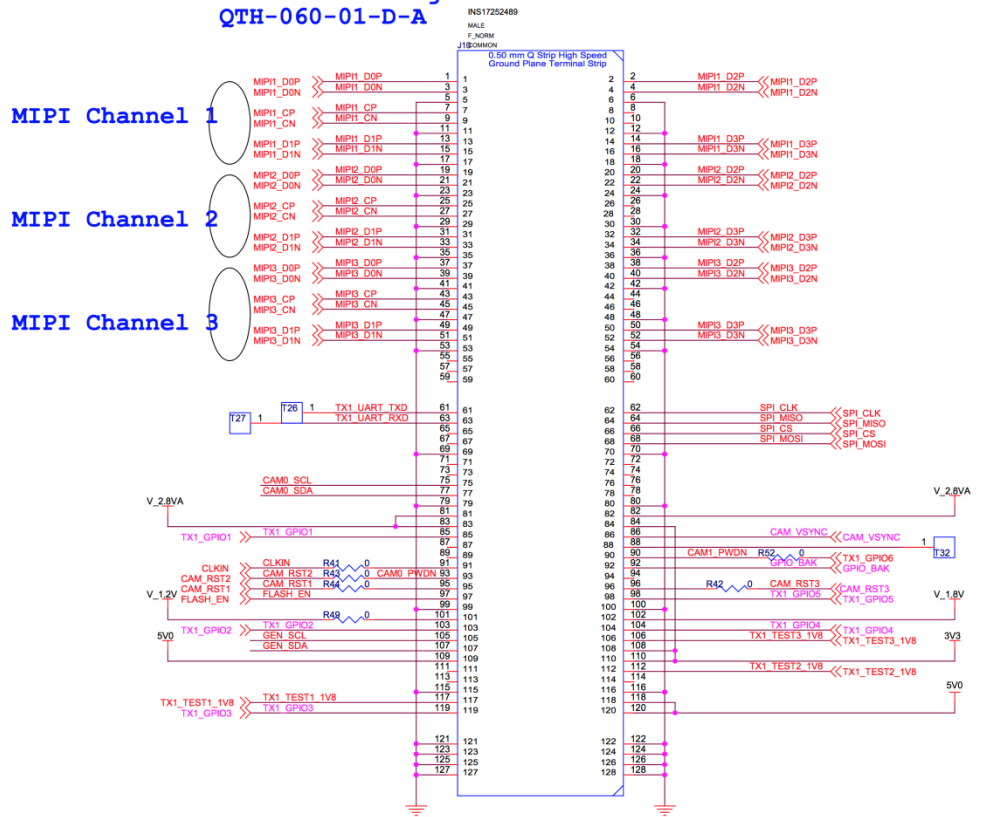
Leopard Imaging Inc.

48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
 Phone: +1-408-263-0988
 Fax: +1-408-217-1960
 Email: sales@leopardimaging.com
 Website: www.leopardimaging.com

Interface J10

- Part#: QTH-060-01-L-D-A
- Number of Positions: 120
- Number of Rows: 2
- Pitch: 0.5 mm

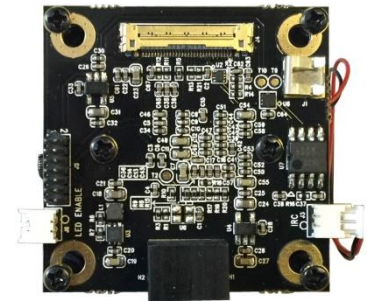
Vertical Mating connector of Jetson TX1 J22 QTH-060-01-D-A



Leopard Imaging Inc.

48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
 Phone: +1-408-263-0988
 Fax: +1-408-217-1960
 Email: sales@leopardimaging.com
 Website: www.leopardimaging.com

LI-IMX385-MIPI-CS



Camera Spec	
Image Sensor	Sony Diagonal 8.35mm Type 1/2 CMOS Image Sensor IMX385LQR
Optical format	1/2"
Number of active pixels	1937 (H) x 1097(V)
Pixel size	3.75um (H) x 3.75um (V)
Color or Mono	Color
Interface	MIPI interface
Lens mount	CS
IR switcher	Support
Weight	58 g
Interfaces	
Interface J4: <ul style="list-style-type: none"> Part#: 20525-030E-02C Number of Positions: 30 Pitch: 0.4mm Mating I-PEX cable: FAW-1233-03 (300mm) 	
Interface J3: <ul style="list-style-type: none"> Part#: 1734829-2 Number of Positions: 2 Pitch: 1.25mm 	
Interface J6: <ul style="list-style-type: none"> Part#: 1734829-2 Number of Positions: 2 Pitch: 1.25mm 	



Leopard Imaging Inc.

48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA
 Phone: +1-408-263-0988
 Fax: +1-408-217-1960
 Email: sales@leopardimaging.com
 Website: www.leopardimaging.com

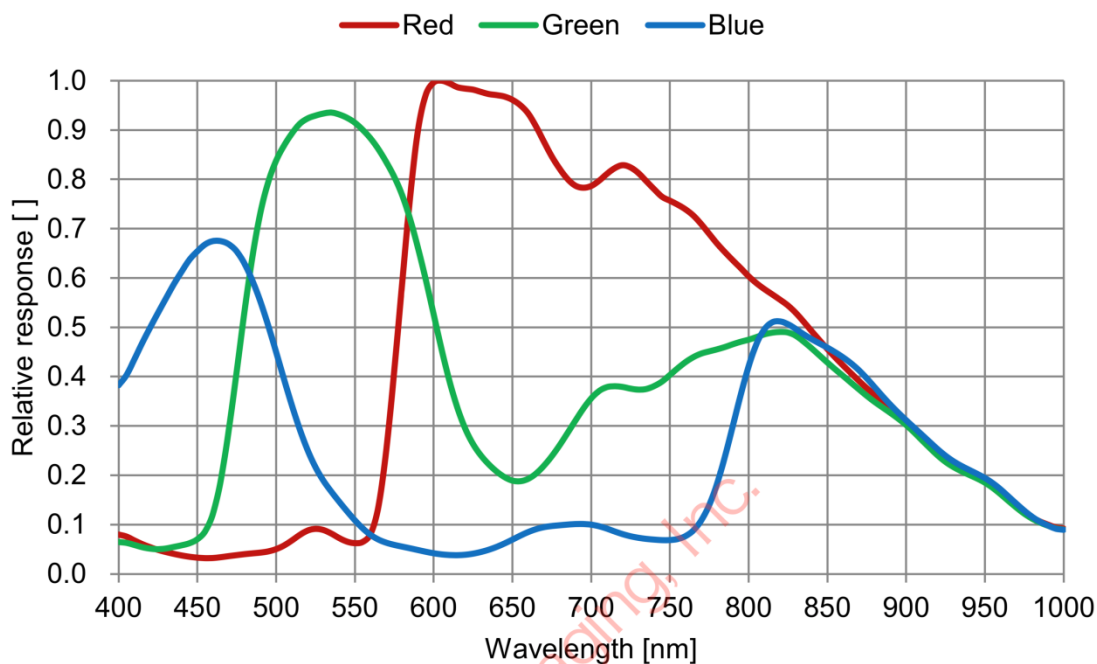
Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage (analog 3.3 V)	AV _{DD}	-0.3	4.0	V	—
Supply voltage (interface 1.8 V)	OV _{DD}	-0.3	3.3	V	—
Supply voltage (digital 1.2 V)	DV _{DD}	-0.3	2.0	V	—
Input voltage	VI	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V
Output voltage	VO	-0.3	OV _{DD} + 0.3	V	Not exceed 3.3 V
Operating temperature	Topr	-30	85	°C	—
Storage temperature	Tstg	-40	85	°C	—

Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Unit
Supply voltage (analog 3.3 V)	AV _{DD}	3.15	3.30	3.45	V
Supply voltage (Interface 1.8 V)	OV _{DD}	1.70	1.80	1.90	V
Supply voltage (digital 1.2 V)	DV _{DD}	1.10	1.20	1.30	V

Spectral Sensitivity Characteristics



DC Characteristics

Item	Pins	Symbol	Condition	Min.	Typ.	Max.	Unit	
Supply voltage	analog	VDDHx	AV _{DD}	—	3.15	3.30	3.45	V
	Interface	VDDMx	OV _{DD}	—	1.70	1.80	1.90	V
	digital	VDDLx	DV _{DD}	—	1.10	1.20	1.30	V
Digital input voltage	XHS XVS XCLR INCK XMASTER OMODE SCK SDI XCE XTRIG	VIH	XVS / XHS Slave Mode	0.8OV _{DD}	—	—	V	
		VIL		—	—	0.2OV _{DD}	V	
Digital output voltage	DLOP [A:H] DLOM [A:H] DLCKP DLCKM	VCM	Low voltage LVDS	—	OV _{DD} /2	—	V	
		VOD	Low voltage LVDS (Termination resistance: 100 Ω)	100	150	220	mV	
	XHS XVS SDO TOUT	VOH	XVS / XHS Master Mode	OV _{DD} -0.4	—	—	V	
		VOL		—	—	0.4	V	

Power Consumption

Item	pin	Symbol	Typ.		Max.		Unit
			Standard luminous intensity	Saturated luminous intensity	Standard luminous intensity	Saturated luminous intensity	
Operating current Low voltage LVDS serial 4 ch 12 bit 60 frame / s All pixel scan mode	VDDH	IAV _{DD}	85	85	140	140	mA
	VDDM	IOV _{DD}	15	15	25	25	mA
	VDDL	IDV _{DD}	80	100	135	170	mA
Operating current MIPI CSI-2 / 4 lane 12 bit 60 frame / s All pixel scan mode	VDDH	IAV _{DD}	85	85	140	140	mA
	VDDM	IOV _{DD}	1	1	5	5	mA
	VDDL	IDV _{DD}	92	112	155	185	mA
Standby current	VDDH	IAV _{DD_STB}	—	—	0.1	—	mA
	VDDM	IOV _{DD_STB}	—	—	0.1	—	mA
	VDDL	IDV _{DD_STB}	—	—	14	—	mA

Operating current: (Typ.) Supply voltage 3.3 V / 1.8 V / 1.2 V, T_j = 25 °C
(Max.) Supply voltage 3.45 V / 1.9 V / 1.3 V, T_j = 60 °C, worst state of internal circuit operating current consumption,

Standby: (Max.) Supply voltage 3.45 V / 1.9 V / 1.3 V, T_j = 60 °C, INCK: 0 V,
The device in the light-obstructed state.

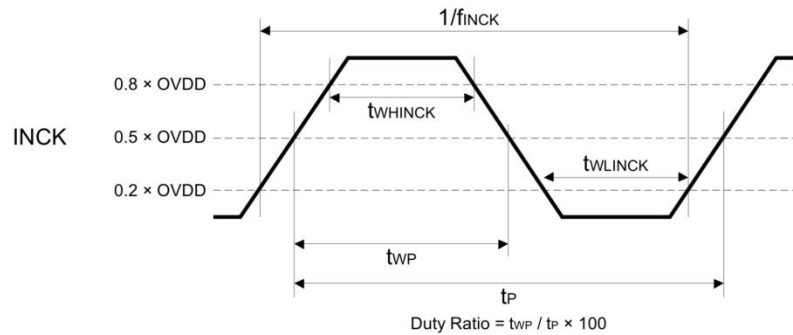
Standard luminous intensity: luminous intensity at 1/3 of the sensor saturated.

Saturated luminous intensity: luminous intensity when the sensor is saturated.



AC Specification

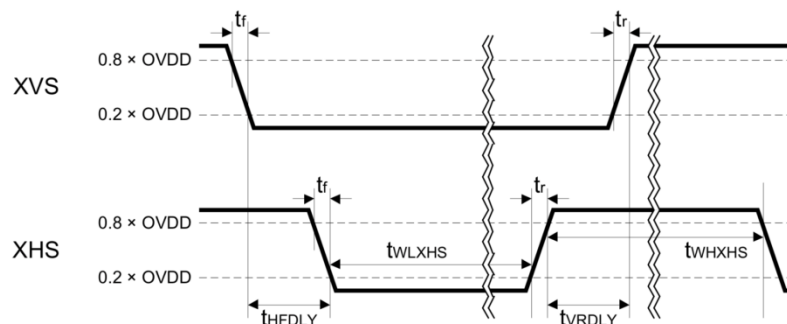
Master Clock Waveform (INCK)



Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
INCK clock frequency	f_{INCK}	$f_{INCK} \times 0.96$	f_{INCK}	$f_{INCK} \times 1.02$	MHz	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK Low level pulse width	t_{WLINCK}	4	—	—	ns	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK High level pulse width	t_{WHINCK}	4	—	—	ns	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK clock duty	—	45.0	50.0	55.0	%	Define with $0.5 \times OV_{DD}$

*The INCK fluctuation affects the frame rate.

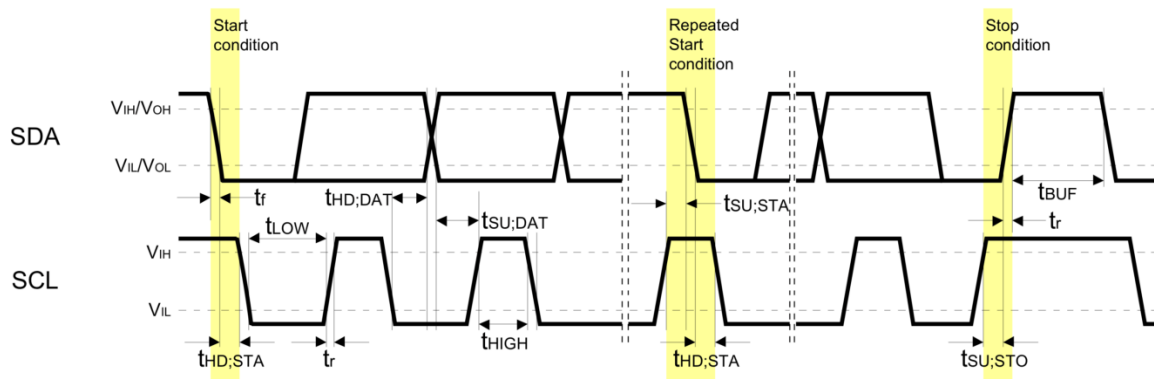
XVS / XHS Input Characteristics In Slave Mode (DMODE pin = High)



Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
XHS Low level pulse width	t_{WLXHS}	$4 / f_{INCK}$	—	—	ns	—
XHS High level pulse width	t_{WHXHS}	$4 / f_{INCK}$	—	—	ns	—
XVS - XHS fall width	t_{HFDLY}	$1 / f_{INCK}$	—	—	ns	—
XHS - XVS rise width	t_{VRDLY}	$1 / f_{INCK}$	—	—	ns	—
XVS, XHS rise time	t_r	—	—	5	ns	20 % to 80 %
XVS, XHS fall time	t_f	—	—	5	ns	80 % to 20 %



I²C Communication



I²C Specification

Item	Symbol	Min.	Typ.	Max.	Unit	条件
Low level input voltage	VIL	-0.3	—	$0.3 \times \text{OVDD}$	V	—
High level input voltage	VIH	$0.7 \times \text{OVDD}$	—	1.9	V	—
Low level input voltage	VOL	0	—	$0.2 \times \text{OVDD}$	V	OVDD < 2 V, Sink 3 mA
High level input voltage	VOH	$0.8 \times \text{OVDD}$	—	—	V	—
Output fall time	tof	—	—	250	ns	Load 10 pF – 400 pF, $0.7 \times \text{OVDD} - 0.3 \times \text{OVDD}$
Input current	li	-10	—	10	μA	$0.1 \times \text{OVDD} - 0.9 \times \text{OVDD}$
Capacitance for SCK (SCL) /SDI (SDA)	Ci	—	—	10	pF	—

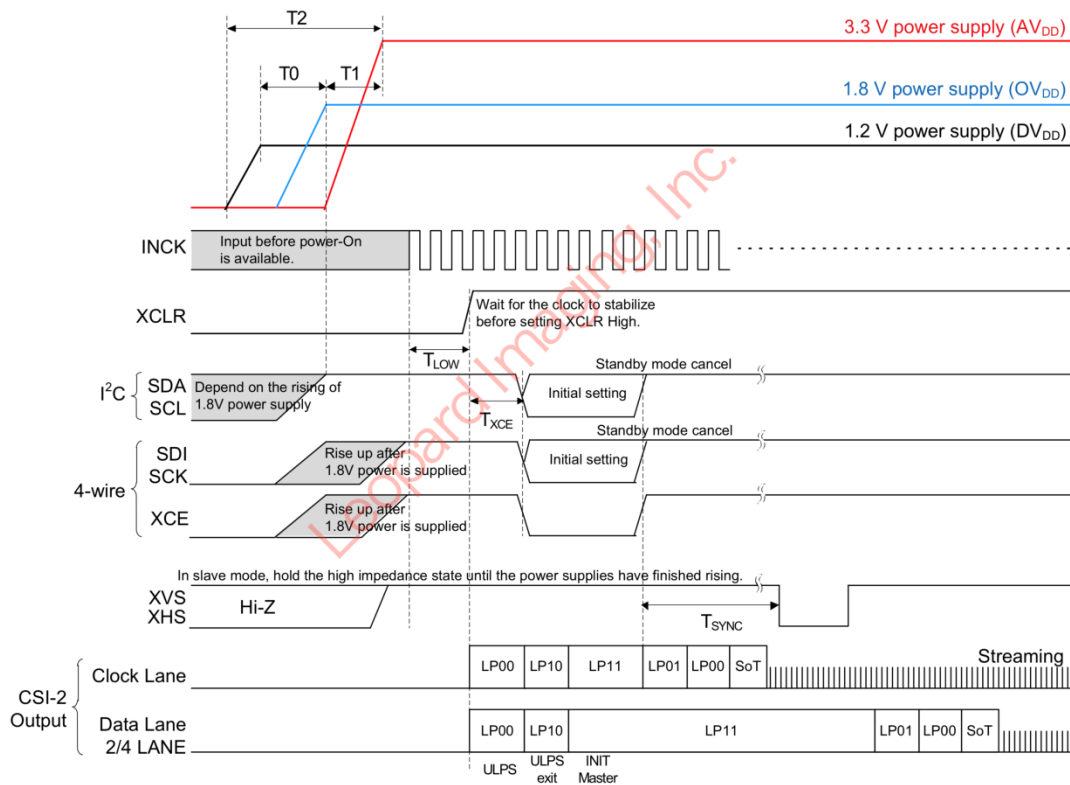
I²C AC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
SCL clock frequency	f _{SCL}	0	—	400	kHz
Hold time (Start Condition)	t _{HD:STA}	0.6	—	—	μs
Low period of the SCL clock	t _{LOW}	1.3	—	—	μs
High period of the SCL clock	t _{HIGH}	0.6	—	—	μs
Set-up time (Repeated Start Condition)	t _{SU:STA}	0.6	—	—	μs
Data hold time	t _{HD:DAT}	0	—	0.9	μs
Data set-up time	t _{SU:DAT}	100	—	—	ns
Rise time of both SDA and SCL signals	t _r	—	—	300	ns
Fall time of both SDA and SCL signals	t _f	—	—	300	ns
Set-up time (Stop Condition)	t _{SU:STO}	0.6	—	—	μs
Bus free time between a STOP and START Condition	t _{BUF}	1.3	—	—	μs



Power-on Sequence

1. Turn On the power supplies so that the power supplies rise in order of 1.2 V power supply (DV_{DD}) → 1.8 V power supply (OV_{DD}) → 3.3 V power supply (AV_{DD}). In addition, all power supplies should finish rising within 200 ms.
2. Start master clock (INCK) input after turning On the power supplies.
3. The register values are undefined immediately after power-on, so the system must be cleared. Hold XCLR at Low level for 500 ns or more after all the power supplies have finished rising. (The register values after a system clear are the default values.) In addition, hold XCE to High level during this period. Rise XCE after 1.8 V power supply (OV_{DD}).
4. The system clear is applied by setting XCLR to High level. However, the maser clock needs to stabilize before setting the XCLR pin to High level.
5. Make the sensor setting by register communication after the system clear. A period of 20 μs or more should be provided after setting XCLR High before inputting the communication enable signal XCE. In I²C communication, XCE is fixed to High.

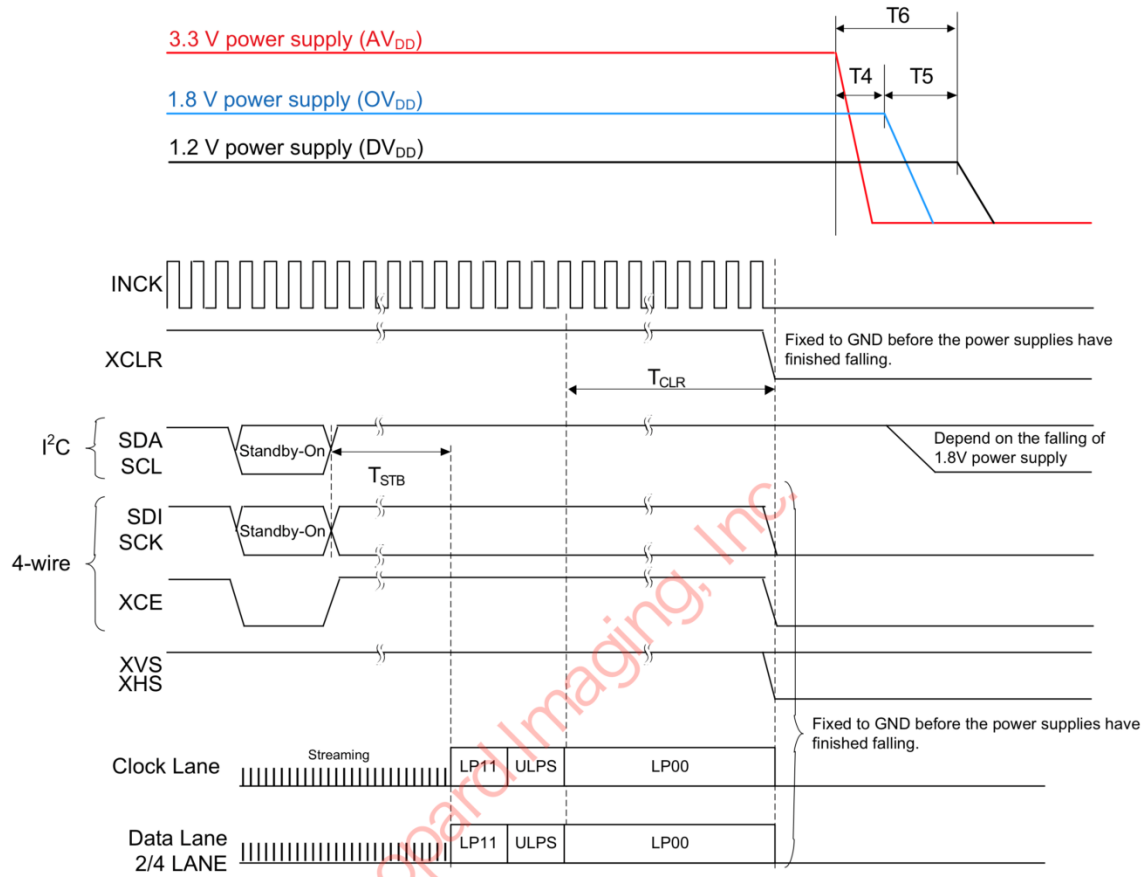


Item	Symbol	Min.	Max.	Unit
1.2 V power supply rising → 1.8 V power supply rising	T ₀	0	—	ns
1.8 V power supply rising → 3.3 V power supply rising	T ₁	0	—	ns
Rising time of all power supply	T ₂	—	200	ms
INCK active → Clear OFF	T _{LOW}	500	—	ns
Clear OFF → Communication start	T _{XCE}	20	—	μs
Standby OFF (communication) → External input XHS,XVS (slave mode only)	T _{SYNC}	20	—	ms



Power-off Sequence

Turn Off the power supplies so that the power supplies fall in order of 3.3 V power supply (AV_{DD}) → 1.8 V power supply (OV_{DD}) → 1.2 V power supply (DV_{DD}). In addition, all power supplies should falling within 200 ms. Set each digital input pin (INCK, XCE, SCK, SDI, XCLR, XMASTER, OMODE, XVS, XHS) to 0 V before the 1.8 V power supply (OV_{DD}) falls.



Item	Symbol	Min.	Max.	Unit
Standby ON (communication) → LP11 mode start	T_{STB}	Until FE		—
LP00 → XCLR falling	T_{CLR}	128	—	cycle
3.3 V power shut down → 1.8 V power shut down	T4	0	—	ns
1.8 V power shut down → 1.2 V power shut down	T5	0	—	ns
Shut down time of all power supply	T6	—	200	ms

